

PHOTOCOUPLER PS8741

FOR OPTICAL DAA, HIGH LINEAR 16-PIN SOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS8741 is an optically coupled isolator containing a GaAs LED on the input side and two photodiodes on the output side.

It is suitable for analog control applications such as PCMCIA card, modem, voice telephony and fax machines.

FEATURES

- For PCMCIA
- Small and thin package (16-pin SOP: Pin pitch = 1.27 mm, Height = 2.1 mm)
- High transfer gain linearity ($\Delta K_3 = 1\%$ MAX.)
- High isolation voltage (BV = 1 500 Vr.m.s.)
- Ordering number of taping product: PS8741-F3, F4: 2 500 pcs/reel
- Safety standards
 - UL approved: File No. E72422

APPLICATIONS

- PCMCIA card
- Notebook PC, PDA
- Modem
- Telephone, FAX

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PACKAGE DIMENSIONS (UNIT: mm)



MARKING



★ ORDERING INFORMATION

| Part Number | Order Number | Solder plating Specification | Packing Style | Safety Standard | Application Part Number *1 |
|-------------|--------------|---------------------------------|------------------------------|-------------------|-------------------------------|
| PS8741 | PS8741 | Solder | Magazine case 45 pcs | Standard products | PS8741 |
| PS8741-F3 | PS8741-F3 | contains lead | Embossed Tape 2 500 pcs/reel | (UL Approved) | |
| PS8741-F4 | PS8741-F4 | | | | |
| PS8741 | PS8741-A | Pb-Free | Magazine case 45 pcs | | |
| PS8741-F3 | PS8741-F3-A | | Embossed Tape 2 500 pcs/reel | | |
| PS8741-F4 | PS8741-F4-A | | | | |

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|-------------------------------|-------------------------|--------|-------------|---------|
| Diode | Forward Current (DC) | lf | 50 | mA |
| | Reverse Voltage | Vr | 3 | V |
| | Power Dissipation | PD | 80 | mW/ch |
| | Peak Forward Current *1 | IFP | 0.5 | А |
| Detector | Reverse Voltage | Vr | 20 | V |
| | Power Dissipation | Pc | 50 | mW/ch |
| Isolation Voltage *2 | | BV | 1 500 | Vr.m.s. |
| Total Power Dissipation | | Рт | 180 | mW |
| Operating Ambient Temperature | | TA | -40 to +85 | °C |
| Storage Temperature | | Tstg | -40 to +100 | °C |

*1 PW = 100 *µ*s, Duty Cycle = 1%

*2 AC voltage for 1 minute at T_{A} = 25°C, RH = 60% between input and output

ELECTRICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

| Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|-----------|---|--------|---|------|-------|------|------|
| Diode | Forward Voltage | VF | IF = 5 mA | | 1.1 | 1.4 | V |
| | Reverse Current | IR | V _R = 3 V | | | 10 | μA |
| | Terminal Capacitance | Ct | V = 0 V, f = 1 MHz | | 30 | | pF |
| Detector | Dark Current | lo | Vcc = 5 V, I _F = 0 mA | | 1 | 25 | nA |
| Coupled | Servo Gain (IpD1/IF) | K1 | Vcc = 5 V, IF = 2 mA | 0.3 | 1.0 | 1.8 | % |
| | Forward Gain (IPD2/IF) | K2 | | 0.3 | 1.0 | 1.8 | |
| | Transfer Gain (K ₂ /K ₁) | Kз | Vcc = 5 V, IF = 2 mA | 0.75 | 1.0 | 1.25 | |
| | Transfer Gain Linearity | ⊿Кз | Vcc = 5 V, IF = 2 to 10 mA | | 0.3 | 1 | % |
| | K ₃ Temperature Coefficient | ⊿K₃/⊿T | $V_{CC} = 5 \text{ V}, \text{ I}_F = 2 \text{ to } 10 \text{ mA},$ TA = -40 to +85°C | | 0.005 | | %/°C |

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

SERVO CURRENT vs. FORWARD CURRENT



PHOTO CURRENT vs. FORWARD CURRENT



TRANSFER GAIN vs. FORWARD CURRENT



Remark The graphs indicate nominal characteristics.



FORWARD GAIN vs. FORWARD CURRENT







TAPING SPECIFICATIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- · Peak reflow temperature
- · Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature
- Time
- 10 seconds or less · Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)

260°C or below (molten solder temperature)

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine • Flux content of 0.2 Wt% is recommended.)

(3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) | Concentration contained in CEL devices | | | |
|----------------------------------|--|---|--------------|--|--|
| Lead (Pb) | < 1000 PPM | -A Not Detected | -AZ (*) | | |
| Mercury | < 1000 PPM | Not Detected | | | |
| Cadmium | < 100 PPM | | Not Detected | | |
| Hexavalent Chromium | < 1000 PPM | Not Detected | | | |
| РВВ | < 1000 PPM | Not Detected | | | |
| PBDE | < 1000 PPM | Not De | etected | | |

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.

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